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Manual on

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The Use of  
Thermocouples  
in Temperature  
Measurement

Fourth Edition

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# MANUAL ON THE USE OF THERMOCOUPLES IN TEMPERATURE MEASUREMENT

**Fourth Edition**

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# Foreword

The Manual on the Use of Thermocouples in Temperature Measurement was sponsored by ASTM Committee E20 on Temperature Measurement and was compiled by E20.94, the Publications Subcommittee. The editorial work was co-ordinated by R. M. Park, Marlin Manufacturing Corp. Helen M. Hoersch was the ASTM editor.

# Contents

Chapter 1—Introduction	1
Chapter 2—Principles of Thermoelectric Thermometry	4
2.0 Introduction	4
2.1 Practical Thermoelectric Circuits	5
2.1.1 The Thermoelectric Voltage Source	5
2.1.2 Absolute Seebeck Characteristics	5
2.1.2.1 The Fundamental Law of Thermoelectric Thermometry	8
2.1.2.2 Corollaries from the Fundamental Law of Thermoelectric Thermometry	10
2.1.2.3 The Seebeck EMF Cell	10
2.1.3 Inhomogeneous Thermoelements	11
2.1.4 Relative Seebeck Characteristics	11
2.2 Analysis of Some Practical Thermoelectric Circuits	18
2.2.1 Example: An Ideal Thermocouple Assembly	21
2.2.2 Example: A Nominal Base-Metal Thermocouple Assembly	22
2.2.3 Example: A Normal Precious-Metal Thermocouple Assembly with Improper Temperature Distribution	25
2.3 Historic Background	28
2.3.1 The Seebeck Effect	29
2.3.2 The Peltier Effect	30
2.3.3 The Thomson Effect	31
2.4 Elementary Theory of the Thermoelectric Effects	32
2.4.1 Traditional “Laws” of Thermoelectric Circuits	33
2.4.1.1 The “Law” of Homogeneous Metals	33
2.4.1.2 The “Law” of Intermediate Metals	33
2.4.1.3 The “Law” of Successive or Intermediate Temperatures	33
2.4.2 The Mechanisms of Thermoelectricity	34

2.4.3	The Thermodynamics of Thermoelectricity	36
2.4.3.1	The Kelvin Relations	36
2.4.3.2	The Onsager Relations	38
2.5	Summary of Chapter 2	39
2.6	References	40
2.7	Nomenclature	41
Chapter 3	—Thermocouple Materials	43
3.1	Common Thermocouple Types	43
3.1.1	General Application Data	45
3.1.2	Properties of Thermoelement Materials	48
3.2	Extension Wires	51
3.2.1	General Information	51
3.2.2	Sources of Error	54
3.3	Nonstandardized Thermocouple Types	62
3.3.1	Platinum Types	63
3.3.1.1	Platinum-Rhodium Versus Platinum-Rhodium Thermocouples	63
3.3.1.2	Platinum-15% Iridium Versus Palladium Thermocouples	65
3.3.1.3	Platinum-5% Molybdenum Versus Platinum-0.8% Cobalt Thermocouples	67
3.3.2	Iridium-Rhodium Types	68
3.3.2.1	Iridium-Rhodium Versus Iridium Thermocouples	68
3.3.2.2	Iridium-Rhodium Versus Platinum-Rhodium Thermocouples	69
3.3.3	Platinel Types	71
3.3.3.1	Platinel Thermocouples	71
3.3.3.2	Pallador I	73
3.3.3.3	Pallador II	74
3.3.4	Nickel-Chromium Types	75
3.3.4.1	Nickel Chromium Alloy Thermocouples	75
3.3.4.1.1	Geminol	75
3.3.4.1.2	Thermo-Kanthal Special	75
3.3.4.1.3	Tophel II-Nial II	75
3.3.4.1.4	Chromel 3-G-345-Alumel 3-G-196	77
3.3.5	Nickel-Molybdenum Types	78

3.3.5.1	20 Alloy and 19 Alloy (Nickel Molybdenum-Nickel Alloys)	78
3.3.6	Tungsten-Rhenium Types	78
3.3.7	Gold Types	81
3.3.7.1	Thermocouples Manufactured from Gold Materials	81
3.3.7.2	KP or EP Versus Gold-0.07 Atomic Percent Iron Thermocouples	82
3.3.7.3	Gold Versus Platinum Thermocouples	83
3.4	Compatibility Problems at High Temperatures	84
3.5	References	84
Chapter 4	—Typical Thermocouple Designs	87
4.1	Sensing Element Assemblies	88
4.2	Nonceramic Insulation	88
4.3	Hard-Fired Ceramic Insulators	93
4.4	Protecting Tubes, Thermowells, and Ceramic Tubes	95
4.4.1	Factors Affecting Choice of Protection for Thermocouples	95
4.4.2	Common Methods of Protecting Thermocouples	97
4.4.2.1	Protecting Tubes	97
4.4.2.2	Thermowells	98
4.4.2.3	Ceramic Tubes	98
4.4.2.4	Metal-Ceramic Tubes	98
4.5	Circuit Connections	99
4.6	Complete Assemblies	100
4.7	Selection Guide for Protecting Tubes	100
4.8	Bibliography	107
Chapter 5	—Sheathed, Compacted, Ceramic-Insulated Thermocouples	108
5.1	General Considerations	108
5.2	Construction	108
5.3	Insulation	110
5.4	Thermocouple Wires	112
5.5	Sheath	112
5.6	Combinations of Sheath, Insulation, and Wire	112
5.7	Characteristics of the Basic Material	112
5.8	Testing	113
5.9	Measuring Junction	117
5.10	Terminations	122

5.11	Installation of the Finished Thermocouple	122
5.12	Sheathed Thermocouple Applications	122
5.13	References	124
Chapter 6—	Thermocouple Output Measurements	125
6.1	General Considerations	125
6.2	Deflection Millivoltmeters	125
6.3	Digital Voltmeters	126
6.4	Potentiometers	126
6.4.1	Potentiometer Theory	126
6.4.2	Potentiometer Circuits	127
6.4.3	Types of Potentiometer Instruments	128
6.4.3.1	Laboratory High Precision Type	128
6.4.3.2	Laboratory Precision Type	128
6.4.3.3	Portable Precision Type	129
6.4.3.4	Semiprecision Type	129
6.4.3.5	Recording Type	129
6.5	Voltage References	129
6.6	Reference Junction Compensation	130
6.7	Temperature Transmitters	130
6.8	Data Acquisition Systems	131
6.8.1	Computer Based Systems	131
6.8.2	Data Loggers	131
Chapter 7—	Reference Junctions	132
7.1	General Considerations	132
7.2	Reference Junction Techniques	132
7.2.1	Fixed Reference Temperature	133
7.2.1.1	Triple Point of Water	133
7.2.1.2	Ice Points	133
7.2.1.3	Automatic Ice Point	135
7.2.1.4	Constant Temperature Ovens	135
7.2.2	Electrical Compensation	136
7.2.2.1	Zone Box	137
7.2.2.2	Extended Uniform Temperature Zone	138
7.2.3	Mechanical Reference Compensation	138
7.3	Sources of Error	138
7.3.1	Immersion Error	138
7.3.2	Galvanic Error	139
7.3.3	Contaminated Mercury Error	139
7.3.4	Wire Matching Error	139
7.4	References	139



Chapter 8—Calibration of Thermocouples	141
8.1 General Considerations	141
8.1.1 Temperature Scale	141
8.1.2 Reference Thermometers	142
8.1.2.1 Resistance Thermometers	142
8.1.2.2 Liquid-in-Glass Thermometers	144
8.1.2.3 Types E and T Thermocouples	144
8.1.2.4 Types R and S Thermocouples	144
8.1.2.5 High Temperature Standards	144
8.1.3 Annealing	144
8.1.4 Measurement of Emf	145
8.1.5 Homogeneity	146
8.1.6 General Calibration Methods	147
8.1.7 Calibration Uncertainties	148
8.1.7.1 Uncertainties Using Fixed Points	149
8.1.7.2 Uncertainties Using Comparison Methods	150
8.2 Calibration Using Fixed Points	151
8.2.1 Freezing Points	151
8.2.2 Melting Points	152
8.3 Calibration Using Comparison Methods	153
8.3.1 Laboratory Furnaces	153
8.3.1.1 Noble-Metal Thermocouples	153
8.3.1.2 Base-Metal Thermocouples	155
8.3.2 Stirred Liquid Baths	156
8.3.3 Fixed Installations	156
8.4 Interpolation Methods	158
8.5 Single Thermolement Materials	161
8.5.1 Test Specimen	163
8.5.2 Reference Thermolement	164
8.5.3 Reference Junction	164
8.5.4 Measuring Junction	165
8.5.5 Test Temperature Medium	165
8.5.6 Emf Indicator	165
8.5.7 Procedure	166
8.6 References	167
8.7 Bibliography	168
 Chapter 9—Application Considerations	 169
9.1 Temperature Measurement in Fluids	169
9.1.1 Response	169
9.1.2 Recovery	172
9.1.3 Thermowells	173
9.1.4 Thermal Analysis of an Installation	173

9.2	Surface Temperature Measurement	175
9.2.1	General Remarks	175
9.2.1.1	Measurement Error	175
9.2.1.2	Installation Types	176
9.2.2	Installation Methods	176
9.2.2.1	Permanent Installations	176
9.2.2.2	Measuring Junctions	176
9.2.2.3	Probes	178
9.2.2.4	Moving Surfaces	180
9.2.2.5	Current Carrying Surfaces	180
9.2.3	Sources of Error	180
9.2.3.1	Causes of Perturbation Errors	181
9.2.4	Error Determination	181
9.2.4.1	Steady-State Conditions	181
9.2.4.2	Transient Conditions	182
9.2.5	Procedures for Minimizing Errors	183
9.2.6	Commercial Surface Thermocouples	183
9.2.6.1	Surface Types	183
9.2.6.2	Probe Types	184
9.3	References	185
Chapter 10—Reference Tables for Thermocouples		189
10.1	Thermocouple Types and Initial Calibration	
	Tolerances	189
10.1.1	Thermocouple Types	189
10.1.2	Initial Calibration Tolerances	190
10.2	Thermocouple Reference Tables	190
10.3	Computation of Temperature-Emf Relationships	212
10.3.1	Equations Used to Derive the Reference Tables	212
10.3.2	Polynomial Approximations Giving Temperature as a Function of the Thermocouple Emf	212
10.4	References	213
Chapter 11—Cryogenics		214
11.1	General Remarks	214
11.2	Materials	215
11.3	Reference Tables	216
11.4	References	216

Chapter 12—Temperature Measurement Uncertainty	234
12.1 The General Problem	234
12.2 Tools of the Trade	235
12.2.1 Average and Mean	235
12.2.2 Normal or Gaussian Distribution	235
12.2.3 Standard Deviation and Variance	235
12.2.4 Bias, Precision, and Uncertainty	236
12.2.5 Precision of the Mean	237
12.2.6 Regression Line or Least-Square Line	237
12.3 Typical Applications	237
12.3.1 General Considerations	237
12.3.2 Wire Calibration	238
12.3.3 Means and Profiles	240
12.3.4 Probability Paper	242
12.3.5 Regression Analyses	244
12.4 References	245
 Chapter 13—Terminology	 246
 Appendix I—List of ASTM Standards Pertaining to Thermocouples	  258
 Appendix II—The International Temperature Scale of 1990 (ITS- 90) (Reprinted from <i>Metrologia</i> , with permission)	  260
 Index	 279

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ASTM would like to express its gratitude to the authors of the 1993 Edition of this publication. The original publication made a significant contribution to the technology, and, therefore, ASTM, in its goal to publish books of technical significance, called upon current experts in the field to revise and update this important publication to reflect those changes and advancements that have taken place over the past 10 years.

# List of Figures

- FIG. 2.1—*The Seebeck thermoelectric emf cell. (a) An isolated electric conductor. (b) Seebeck cell equivalent circuit element.* 6
- FIG. 2.2—*Absolute Seebeck thermoelectric characteristics of pure materials. (a) Pure platinum. (b) Pure cobalt.* 7
- FIG. 2.3—*Views of the elementary thermoelectric circuit. (a) Temperature zones of the circuit. (b) Junction temperature/circuit position (T/X) plot. (c) The electric equivalent circuit.* 12
- FIG. 2.4—*The basic thermocouple with different temperature distributions. (a) Measuring junction at the highest temperature. (b) Measuring junction in an isothermal region. (c) Measuring junction at an intermediate temperature.* 14
- FIG. 2.5—*Comparison of absolute and relative Seebeck emfs of representative thermoelements.* 16
- FIG. 2.6—*Thermocouple circuits for thermometry. (a) Single reference junction thermocouple. (b) Dual reference thermocouple circuit. (c) Thermocouple with external reference junctions.* 19
- FIG. 2.7—*Typical practical thermocouple assembly.* 21
- FIG. 2.8—*Junction-temperature/circuit-position (T/X) plot used in error assessment of practical circuits. (a) Consequence of normal temperature distribution on elements of a nominal base-metal thermocouple circuit. (b) Consequence of an improper temperature distribution on a nominal precious-metal thermocouple assembly.* 23
- FIG. 3.1—*Recommended upper temperature limits for Types K, E, J, T thermocouples.* 45
- FIG. 3.2—*Thermal emf of thermoelements relative to platinum.* 58

FIG. 3.3— <i>Error due to <math>\Delta T</math> between thermocouple-extension wire junctions.</i>	59
FIG. 3.4— <i>Thermal emf of platinum-rhodium versus platinum-rhodium thermocouples.</i>	64
FIG. 3.5— <i>Thermal emf of platinum-iridium versus palladium thermocouples.</i>	66
FIG. 3.6— <i>Thermal emf of platinum-molybdenum versus platinum-molybdenum thermocouples.</i>	68
FIG. 3.7— <i>Thermal emf of iridium-rhodium versus iridium thermocouples.</i>	70
FIG. 3.8— <i>Thermal emf of platinel thermocouples.</i>	72
FIG. 3.9— <i>Thermal emf of nickel-chromium alloy thermocouples.</i>	74
FIG. 3.10— <i>Thermal emf of nickel-molybdenum versus nickel thermocouples.</i>	79
FIG. 3.11— <i>Thermal emf of tungsten-rhenium versus tungsten-rhenium thermocouples.</i>	82
FIG. 4.1— <i>Typical thermocouple element assemblies.</i>	89
FIG. 4.2— <i>Cross-section examples of oval and circular hard-fired ceramic insulators.</i>	95
FIG. 4.3— <i>Examples of drilled thermowells.</i>	99
FIG. 4.4— <i>Typical examples of thermocouple assemblies with protecting tubes.</i>	101
FIG. 4.5— <i>Typical examples of thermocouple assemblies using quick disconnect connectors.</i>	102
FIG. 5.1— <i>Compacted ceramic insulated thermocouple showing its three parts.</i>	109
FIG. 5.2— <i>Nominal thermocouple sheath outside diameter versus internal dimensions.</i>	109

FIG. 5.3— <i>Exposed or bare wire junction.</i>	121
FIG. 5.4— <i>Grounded junction.</i>	121
FIG. 5.5— <i>Ungrounded or isolated junction.</i>	121
FIG. 5.6— <i>Reduced diameter junction.</i>	121
FIG. 5.7— <i>Termination with flexible connecting wires.</i>	122
FIG. 5.8— <i>Quick disconnect and screw terminals.</i>	123
FIG. 5.9— <i>Fittings to adapt into process line [up to <math>3.48 \times 10^4</math> kPa (5000 psi)].</i>	123
FIG. 5.10— <i>Braze for high pressure operation [up to <math>6.89 \times 10^5</math> kPa (100 000 psi)].</i>	123
FIG. 5.11— <i>Thermocouple in thermowell.</i>	123
FIG. 6.1— <i>A simple potentiometer circuit.</i>	127
FIG. 7.1— <i>Basic thermocouple circuit.</i>	133
FIG. 7.2— <i>Recommended ice bath for reference junction.</i>	134
FIG. 8.1— <i>Temperature emf plot of raw calibration data for an iron/constantan thermocouple.</i>	159
FIG. 8.2— <i>Difference plot of raw calibration data for an iron/constantan thermocouple.</i>	160
FIG. 8.3— <i>Typical determination of uncertainty envelope (from data of Fig. 8.2).</i>	161
FIG. 8.4— <i>Various possible empirical representations of the thermocouple characteristic (based on a single calibration run).</i>	162
FIG. 8.5— <i>Uncertainty envelope method for determining degree of least squares interpolating equation for a single calibration run (linear).</i>	162



FIG. 8.6— <i>Uncertainty envelope method for determining degree of least squares interpolating equation for a single calibration run (cubic).</i>	163
FIG. 8.7— <i>Circuit diagram for thermal emf test.</i>	164
FIG. 9.1— <i>Graphical presentation of ramp and step changes.</i>	171
FIG. 9.2— <i>Common attachment methods.</i>	177
FIG. 9.3— <i>Separated junction.</i>	178
FIG. 9.4— <i>Types of junction using metal sheathed thermocouples.</i>	179
FIG. 9.5— <i>Thermocouple probe with auxiliary heater, diagrammatic arrangement.</i>	179
FIG. 9.6— <i>Three wire Type K thermocouple to compensate for voltage drop induced by surface current. (Other materials may be used.)</i>	180
FIG. 9.7— <i>Commercially available types of surface thermocouples.</i>	184
FIG. 9.8— <i>Commercial probe thermocouple junctions.</i>	185
FIG. 11.1— <i>Seebeck coefficients for Types E, K, T, and KP versus Au-0.07 Fe.</i>	215
FIG. 12.1— <i>Bias of a typical Type K wire.</i>	239
FIG. 12.2— <i>Typical probability plot.</i>	242
FIG. 12.3— <i>Typical probability plot—truncated data.</i>	243
APPENDIX II FIG. 1— <i>The differences (<math>t_{90} - t_{68}</math>) as a function of Celsius temperature <math>t_{90}</math>.</i>	263

# List of Tables

TABLE 3.1— <i>Recommended upper temperature limits for protected thermocouples.</i>	44
TABLE 3.2— <i>Nominal Seebeck coefficients.</i>	46
TABLE 3.3— <i>Nominal chemical composition of thermoelements.</i>	49
TABLE 3.4— <i>Environmental limitations of thermoelements.</i>	50
TABLE 3.5— <i>Recommended upper temperature limits for protected thermoelements.</i>	52
TABLE 3.6— <i>Seebeck coefficient (thermoelectric power) of thermoelements with respect to Platinum 67 (typical values).</i>	53
TABLE 3.7— <i>Typical physical properties of thermoelement materials.</i>	54
TABLE 3.8— <i>Thermoelements—resistance to change with increasing temperature.</i>	56
TABLE 3.9— <i>Nominal resistance of thermoelements.</i>	57
TABLE 3.10— <i>Extension wires for thermocouples mentioned in Chapter 3.</i>	60
TABLE 3.11— <i>Platinum-rhodium versus platinum-rhodium thermocouples.</i>	65
TABLE 3.12— <i>Platinum-iridium versus palladium thermocouples.</i>	67
TABLE 3.13— <i>Platinum-molybdenum versus platinum-molybdenum thermocouples.</i>	69
TABLE 3.14— <i>Iridium-rhodium versus iridium thermocouples.</i>	71
TABLE 3.15— <i>Platinel thermocouples.</i>	73

TABLE 3.16— <i>Nickel-chromium alloy thermocouples.</i>	76
TABLE 3.17— <i>Physical data and recommended applications of the 20 Alloy/19 Alloy thermocouples.</i>	80
TABLE 3.18— <i>Tungsten-rhenium thermocouples.</i>	83
TABLE 3.19— <i>Minimum melting temperatures of binary systems.</i>	85
TABLE 4.1— <i>Insulation characteristics.</i>	92
TABLE 4.2— <i>U.S. color code of thermocouple and extension wire insulations.</i>	93
TABLE 4.3— <i>Comparison of color codes for T/C extension wire cable.</i>	94
TABLE 4.4— <i>Properties of refractory oxides.</i>	96
TABLE 4.5— <i>Selection guide for protecting tubes.</i>	102
TABLE 5.1— <i>Characteristic of insulating materials used in ceramic-packed thermocouple stock.</i>	111
TABLE 5.2— <i>Thermal expansion coefficient of refractory insulating materials and three common metals.</i>	111
TABLE 5.3— <i>Sheath materials of ceramic-packed thermocouple stock and some of their properties.</i>	114
TABLE 5.4— <i>Compatibility of wire and sheath material [6].</i>	116
TABLE 5.5— <i>Dimensions and wire sizes of typical ceramic-packed material, Ref ASTM E 585.</i>	117
TABLE 5.6— <i>Various characteristics tests and the source of testing procedure applicable to sheathed ceramic-insulated thermocouples.</i>	118
TABLE 8.1— <i>Defining fixed points of ITS-90.</i>	143
TABLE 8.2— <i>Some secondary fixed points. The pressure is 1 standard atm, except for the triple point of benzoic acid.</i>	143

TABLE 8.3— <i>Calibration uncertainties using fixed point techniques.</i>	149
TABLE 8.4— <i>Calibration uncertainties using comparison techniques in laboratory furnaces (Types R or S standards).</i>	149
TABLE 8.5— <i>Calibration uncertainties using comparison techniques in stirred liquid baths.</i>	150
TABLE 8.6— <i>Calibration uncertainties: tungsten-rhenium type thermocouples.</i>	150
TABLE 8.7— <i>Calibration uncertainties using comparison techniques in special furnaces (visual optical pyrometer standard).</i>	151
TABLE 10.1— <i>Tolerances on initial values of emf versus temperature.</i>	191
TABLE 10.2— <i>Type B thermocouples: emf-temperature (°C) reference table and equations.</i>	192
TABLE 10.3— <i>Type B thermocouples: emf-temperature (°F) reference table.</i>	193
TABLE 10.4— <i>Type E thermocouples: emf-temperature (°C) reference table and equations.</i>	194
TABLE 10.5— <i>Type E thermocouples: emf-temperature (°F) reference table.</i>	195
TABLE 10.6— <i>Type J thermocouples: emf-temperature (°C) reference table and equations.</i>	196
TABLE 10.7— <i>Type J thermocouples: emf-temperature (°F) reference table.</i>	197
TABLE 10.8— <i>Type K thermocouples: emf-temperature (°C) reference table and equations.</i>	198
TABLE 10.9— <i>Type K thermocouples: emf-temperature (°F) reference table.</i>	199

TABLE 10.10— <i>Type N thermocouples: emf-temperature (°C) reference table and equations.</i>	200
TABLE 10.11— <i>Type N thermocouples: emf-temperature (°F) reference table.</i>	201
TABLE 10.12— <i>Type R thermocouples: emf-temperature (°C) reference table and equations.</i>	202
TABLE 10.13— <i>Type R thermocouples: emf-temperature (°F) reference table.</i>	203
TABLE 10.14— <i>Type S thermocouples: emf-temperature (°C) reference table and equations.</i>	204
TABLE 10.15— <i>Type S thermocouples: emf-temperature (°F) reference table.</i>	205
TABLE 10.16— <i>Type T thermocouples: emf-temperature (°C) reference table and equations.</i>	206
TABLE 10.17— <i>Type T thermocouples: emf-temperature (°F) reference table.</i>	207
TABLE 10.18— <i>Type B thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	208
TABLE 10.19— <i>Type E thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	208
TABLE 10.20— <i>Type J thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	209
TABLE 10.21— <i>Type K thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	209

TABLE 10.22— <i>Type N thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	210
TABLE 10.23— <i>Type R thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	210
TABLE 10.24— <i>Type S thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	211
TABLE 10.25— <i>Type T thermocouples: coefficients (<math>c_i</math>) of polynomials for the computation of temperatures in °C as a function of the thermocouple emf in various temperature and emf ranges.</i>	211
TABLE 11.1— <i>Type E thermocouple: thermoelectric voltage, <math>E(T)</math>, Seebeck coefficient, <math>S(T)</math>, and derivative of the Seebeck coefficient, <math>dS/dT</math>.</i>	217
TABLE 11.2— <i>Type T thermocouple: thermoelectric voltage, <math>E(T)</math>, Seebeck coefficient, <math>S(T)</math>, and derivative of the Seebeck coefficient, <math>dS/dT</math>.</i>	221
TABLE 11.3— <i>Type K thermocouple: thermoelectric voltage, <math>E(T)</math>, Seebeck coefficient, <math>S(T)</math>, and derivative of the Seebeck coefficient, <math>dS/dT</math>.</i>	225
TABLE 11.4— <i>KP or EP versus gold-0.07 atomic percent iron thermocouple: thermoelectric voltage, Seebeck coefficient, and derivative of the Seebeck coefficient.</i>	229
TABLE 12.1— <i>Accuracy of unsheathed thermocouples.</i>	238
TABLE 12.2— <i>Accuracy of sheathed thermocouples.</i>	240

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